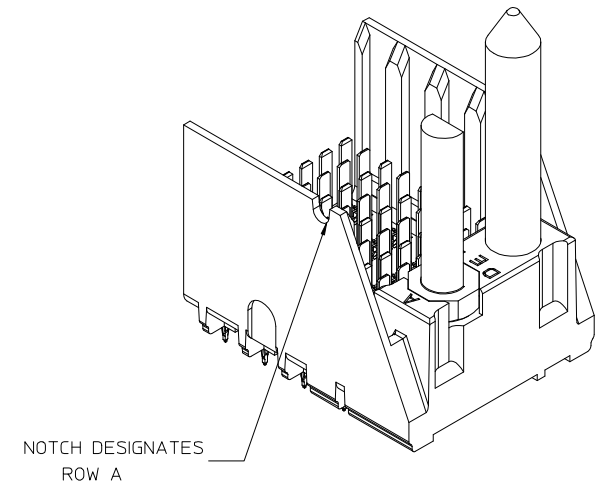
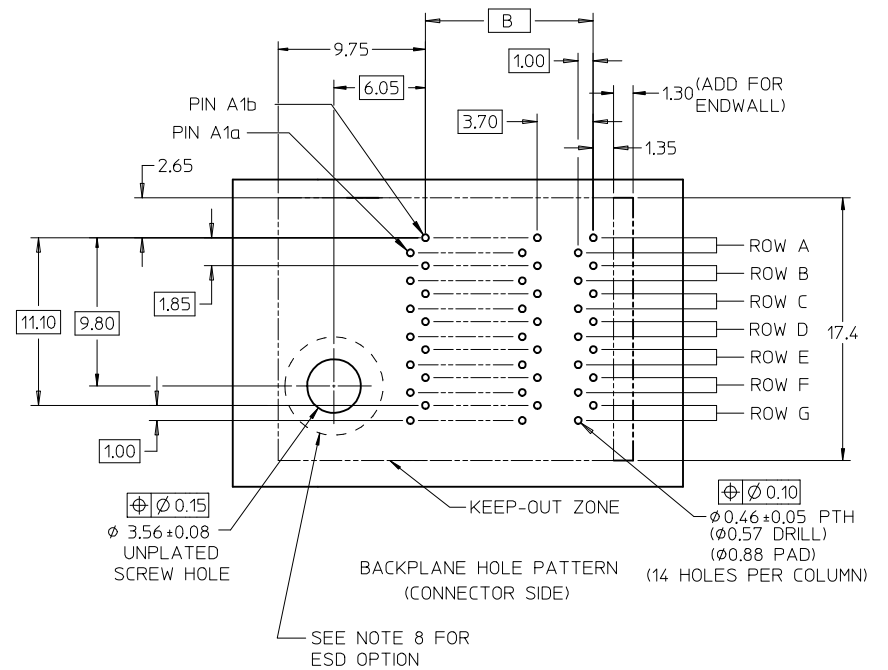
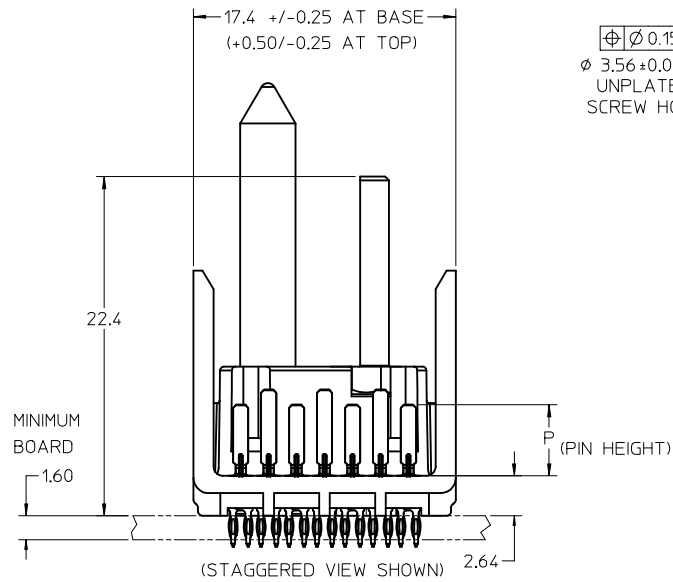
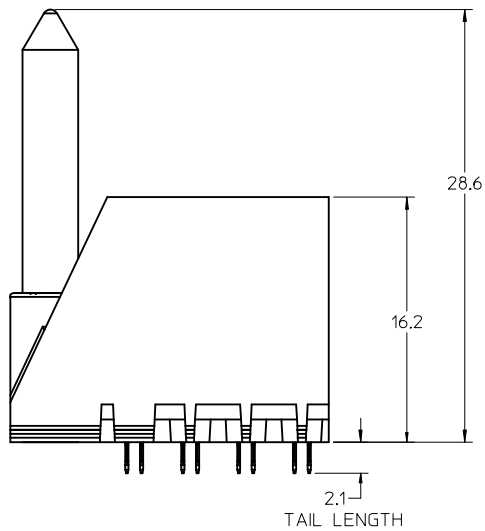
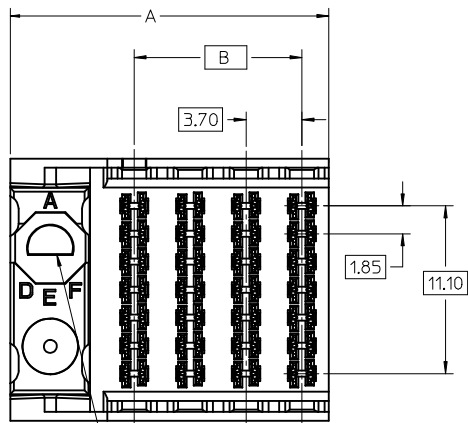




LEADFREE CONVERS. EC NO: UCP2013-1898 DRWN:MP0FF 2012/11/12 CHKD:MM0LFE 2012/11/12 APPR:SMILLER 2012/12/21	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		  		mm	INCH	DRAWN BY BPISZCZOR	DATE 3/28/06	TITLE I-TRAC BACKPLANE 7 ROW GUIDE LEFT ASSEMBLY SALES DRAWING		
			4 PLACES	± ---	± ---	CHECKED BY JLAURX	DATE 2007/02/06			
			3 PLACES	± ---	± ---	APPROVED BY	DATE	molex		
			2 PLACES	± 0.13	± ---	0 PLACE	±			
1 PLACE	± 0.25	± ---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE C THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

76015-****

MODULE TYPE -- TAIL PLATING TYPE
GUIDE LEFT -- TIN ONLY = 2 (PREVIOUSLY TIN/LEAD)
GUIDE LEFT -- TIN ONLY = 3
GUIDE LEFT W/END -- TIN ONLY = 6 (PREVIOUSLY TIN/LEAD)
GUIDE LEFT W/END -- TIN ONLY = 7

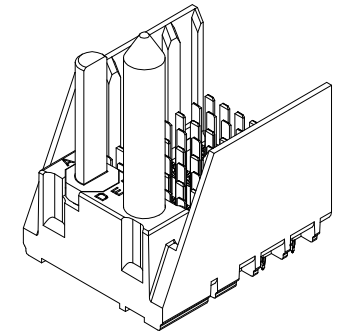
OF COLUMNS
4 = 4 COL
6 = 6 COL
1 = 10 COL

KEY ORIENTATION
0 = NO KEY
1 = A
2 = B
3 = C
4 = D
5 = E
6 = F
7 = G
8 = H

PIN LENGTH (P)
2 = 3.90 - 30 GOLD
3 = 4.70 - 30 GOLD
4 = 5.70 - 30 GOLD
5 = 4.70 & 5.70 - 30 GOLD
STAGGERED
6 = 3.90 - 10 GOLD
7 = 4.70 - 10 GOLD
8 = 5.70 - 10 GOLD
9 = 4.70 & 5.70 - 10 GOLD
STAGGERED

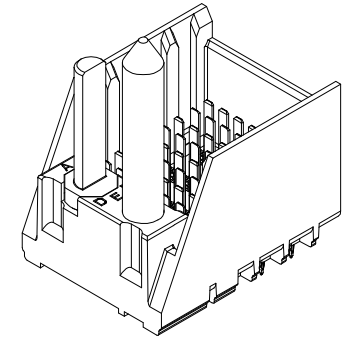
MATERIAL NUMBER	# OF COLUMNS	DIM "A"	DIM "B"
76015-4**	4	21.1	11.10
76015-6**	6	28.5	18.50
76015-1**	10	43.3	33.30

GUIDE LEFT STYLE



MATERIAL NUMBER	# OF COLUMNS	DIM "A"	DIM "B"
76015-4**	4	22.4	11.10
76015-6**	6	29.8	18.50
76015-1**	10	44.6	33.30

GUIDE LEFT W/END STYLE



NOTES:

- MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP)
GLASS-FILLED, UL94V-0
TERMINALS - HIGH PERFORMANCE COPPER ALLOY
- FINISH: 10 MICROINCH MINIMUM GOLD OR 30 MICROINCH MINIMUM GOLD
IN CONTACT AREA. SELECTIVE MATTE TIN ON PCB TAILS,
NICKEL OVERALL.
- REFER TO MOLEX PRODUCT SPECIFICATION PS-75710-999
FOR PERFORMANCE SPECIFICATIONS.
- FOR MIXED CONTACT MATING LENGTHS, CONSULT MOLEX
FOR AVAILABILITY.
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF
COSMETIC SPEC PS-45499-002.
- PACKAGE PER: PK-70873-802.
- GUIDED PARTS TO BE SHIPPED WITH 2-56 UNC B SCREW P/N 73774-1000.
- FOR GROUNDED GUIDE PINS USE DIA 3.56+/-0.08 (PTH),
DIA 3.66 (DRILL), AND DIA 6.5 (PAD).
- REFER TO PCB ROUTING GUIDE FOR ANTIPAD AND ROUTING RECOMMENDATIONS.

SEE SHEET 1 EC NO: UCP2013-1898 DRWN:MP0FF 2012/11/12 CHKD:MMOLF 2012/11/12 APPR:SMILLER 2012/12/21	REV	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	TITLE I-TRAC BACKPLANE 7 ROW GUIDE LEFT ASSEMBLY SALES DRAWING molex		
					mm	INCH	DRAWN BY BPISZCZOR	DATE 3/28/06	DOCUMENT NO. SD-76015-002	SHEET NO. 2 OF 4				
				4 PLACES	± ---	± ---	CHECKED BY JLAURX	DATE 2007/02/06						
				3 PLACES	± ---	± ---	APPROVED BY CBIXLER	DATE 2007/02/06						
				2 PLACES	± 0.13	± ---	SEE TABLE							
				1 PLACE	± 0.25	± ---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS							
				0 PLACE	±	±	ANGULAR ±1/2°							
								SIZE C					THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	

DCARD PCB

BPLANE PCB

CENTERLINE OF
HOLE PATTERN
COLUMN

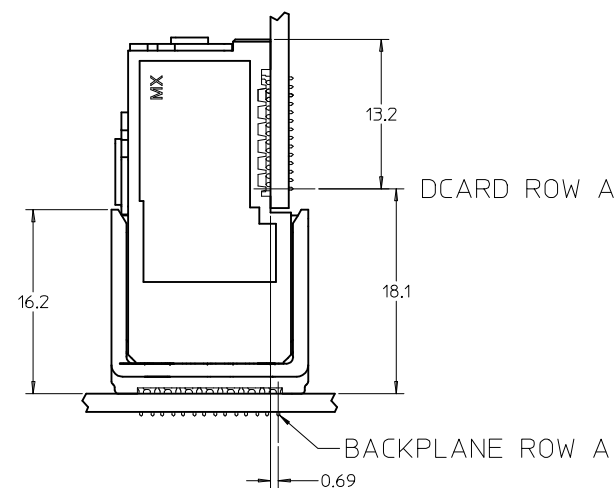
DCARD PCB

BPLANE PCB

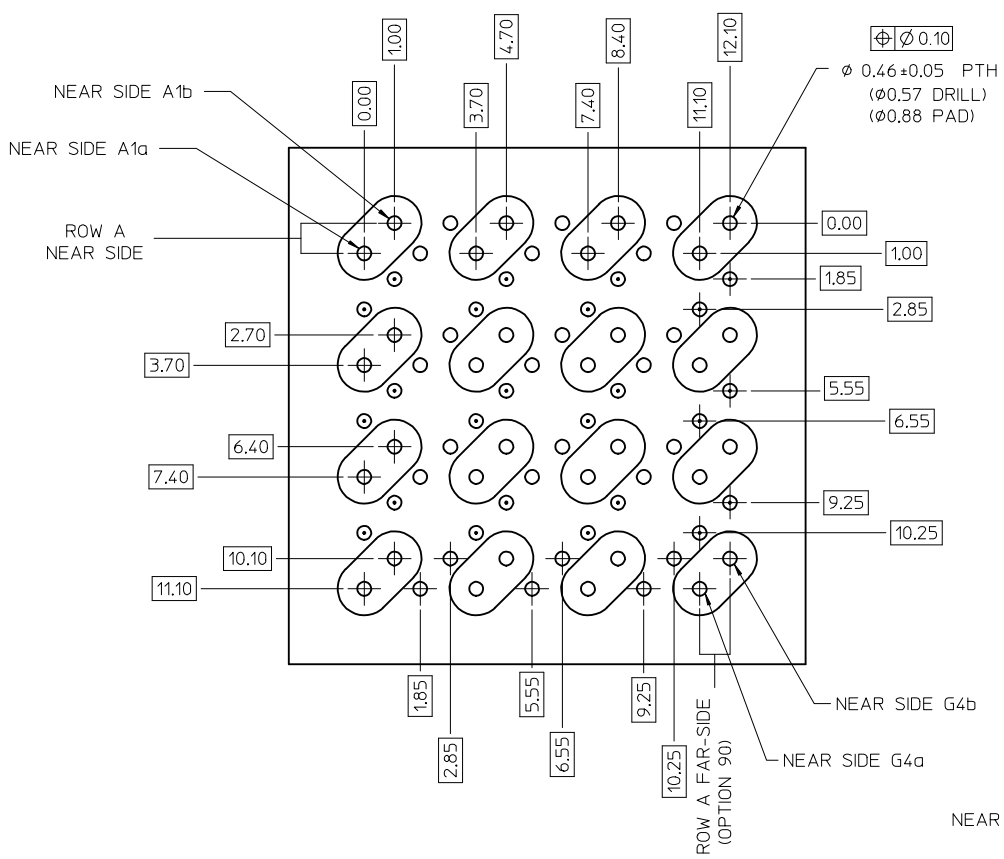
ROW A

ROW A

7 ROW I-TRAC BOARD RELATIONSHIPS



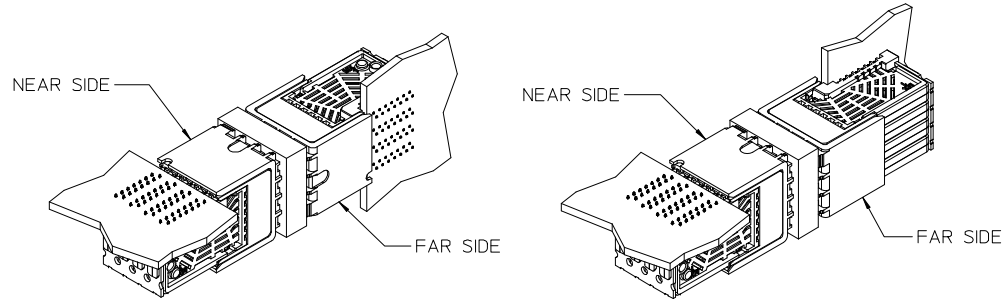
SEE SHEET 1 EC NO: UCP2013-1898 DRWN:MP0FF 2012/11/12 CHKD:MMOLFE 2012/11/12 APPR:SMILLER 2012/12/21	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION
				mm	INCH	DRAWN BY DATE BPISZCZOR 3/28/06		TITLE I-TRAC BACKPLANE 7 ROW GUIDE LEFT ASSEMBLY SALES DRAWING molex DOCUMENT NO. SD-76015-002	
			4 PLACES ± ---	± ---	CHECKED BY DATE JLAURX 2007/02/06				
			3 PLACES ± ---	± ---	APPROVED BY DATE CBIXLER 2007/02/06				
			2 PLACES ± 0.13	± ---	MATERIAL NO.				
			1 PLACE ± 0.25	± ---	SEE TABLE		SHEET NO. 3 OF 4		
			0 PLACE ±	±	SIZE C THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
			ANGULAR ± 1/2°						
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS						



ORTHO PIN MAPPING			
OPTION 90 (NEAR SIDE - FAR SIDE)			
A1b-G4b	A2b-E4b	A3b-C4b	A4b-A4b
A1a-G4a	A2a-E4a	A3a-C4a	A4a-A4a
C1b-G3b	C2b-E3b	C3b-C3b	C4b-A3b
C1a-G3a	C2a-E3a	C3a-C3a	C4a-A3a
E1b-G2b	E2b-E2b	E3b-C2b	E4b-A2b
E1a-G2a	E2a-E2a	E3a-C2a	E4a-A2a
G1b-G1b	G2b-E1b	G3b-C1b	G4b-A1b
G1a-G1a	G2a-E1a	G3a-C1a	G4a-A1a

ORTHO PIN MAPPING			
OPTION 270 (NEAR SIDE - FAR SIDE)			
A1b-A1a	A2b-C1a	A3b-E1a	A4b-G1a
A1a-A1b	A2a-C1b	A3a-E1b	A4a-G1b
C1b-A2a	C2b-C2a	C3b-E2a	C4b-G2a
C1a-A2b	C2a-C2b	C3a-E2b	C4a-G2b
E1b-A3a	E2b-C3a	E3b-E3a	E4b-G3a
E1a-A3b	E2a-C3b	E3a-E3b	E4a-G3b
G1b-A4a	G2b-C4a	G3b-E4a	G4b-G4a
G1a-A4b	G2a-C4b	G3a-E4b	G4a-G4b

Orthogonal PCB Layout



OPTION 90

OPTION 270

- NOTES:
- SIGNAL PAIRS (SHARED VIAS)
 - NEAR SIDE GROUNDS
 - FAR SIDE GROUNDS

SEE SHEET 1 EC NO: UCP2013-1898 DRAWN:MPOFF CHKD:MWOLFE APPR:SMILLER REV	DESCRIPTION 2012/11/12 2012/11/12 2012/12/21	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY BP1SZCZOR	DATE 3/28/06	TITLE I-TRAC BACKPLANE 7 ROW GUIDE LEFT ASSEMBLY SALES DRAWING molex				
			4 PLACES	± ---	± ---	CHECKED BY JLAURX	DATE 2007/02/06					
			3 PLACES	± ---	± ---	APPROVED BY CBIXLER	DATE 2007/02/06	DOCUMENT NO. SD-76015-002				
			2 PLACES	± 0.13	± ---	MATERIAL NO. SEE TABLE						
			1 PLACE	± 0.25	± ---							
			0 PLACE	±	±	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						
			ANGULAR ±1/2°									
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS									

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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